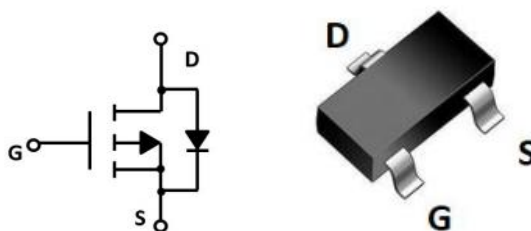




## SOT-23 -30V P Channel Enhancement 沟道增强型 MOS Field Effect Transistor 场效应管



### ■ Absolute Maximum Ratings 最大额定值

Characteristic 特性参数	Symbol 符号	Rat 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	$BV_{DSS}$	-30	V
Gate- Source Voltage 栅极-源极电压	$V_{GS}$	$\pm 12$	V
Drain Current (continuous)漏极电流-连续	$I_D$ (at $T_A = 25^\circ C$ )	-4.4	A
Drain Current (pulsed)漏极电流-脉冲	$I_{DM}$	-17	A
Total Device Dissipation 总耗散功率	$P_D$ (at $T_A = 25^\circ C$ )	1200	mW
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	104	$^\circ C/W$
Junction/Storage Temperature 结温/储存温度	$T_J, T_{stg}$	-55~150	$^\circ C$

### ■ Device Marking 产品字标

AO3401=A19T



## ■ Electrical Characteristics 电特性

( $T_A=25^{\circ}\text{C}$  unless otherwise noted 如无特殊说明, 温度为  $25^{\circ}\text{C}$ )

Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压( $I_D = -250\mu\text{A}, V_{GS}=0\text{V}$ )	$BV_{DSS}$	-30	—	—	V
Gate Threshold Voltage 栅极开启电压( $I_D = -250\mu\text{A}, V_{GS} = V_{DS}$ )	$V_{GS(th)}$	-0.6	-0.9	-1.4	V
Zero Gate Voltage Drain Current 零栅压漏极电流( $V_{GS}=0\text{V}, V_{DS} = -30\text{V}$ )	$I_{DSS}$	—	—	1	$\mu\text{A}$
Gate Body Leakage 栅极漏电流( $V_{GS}=\pm 12\text{V}, V_{DS}=0\text{V}$ )	$I_{GSS}$	—	—	$\pm 100$	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻( $I_D = -4.4\text{A}, V_{GS} = -10\text{V}$ ) ( $I_D = -4\text{A}, V_{GS} = -4.5\text{V}$ ) ( $I_D = -2\text{A}, V_{GS} = -2.5\text{V}$ )	$R_{DS(ON)}$	—	45.5 52 64	55 68 96	$\text{m}\Omega$
Diode Forward Voltage Drop 内附二极管正向压降( $I_{SD} = -4.4\text{A}, V_{GS}=0\text{V}$ )	$V_{SD}$	—	—	-1.2	V
Input Capacitance 输入电容 ( $V_{GS}=0\text{V}, V_{DS} = -15\text{V}, f=1\text{MHz}$ )	$C_{ISS}$	—	1040	—	pF
Common Source Output Capacitance 共源输出电容( $V_{GS}=0\text{V}, V_{DS} = -15\text{V}, f=1\text{MHz}$ )	$C_{OSS}$	—	80	—	pF
Reverse Transfer Capacitance 反馈电容( $V_{GS}=0\text{V}, V_{DS} = -15\text{V}, f=1\text{MHz}$ )	$C_{RSS}$	—	68	—	pF
Total Gate Charge 栅极电荷密度 ( $V_{DS} = -15\text{V}, I_D = -4.4\text{A}, V_{GS} = -10\text{V}$ )	$Q_g$	—	22	—	nC
Gate Source Charge 栅源电荷密度 ( $V_{DS} = -15\text{V}, I_D = -4.4\text{A}, V_{GS} = -10\text{V}$ )	$Q_{gs}$	—	3	—	nC
Gate Drain Charge 栅漏电荷密度 ( $V_{DS} = -15\text{V}, I_D = -4.4\text{A}, V_{GS} = -10\text{V}$ )	$Q_{gd}$	—	2	—	nC
Turn-ON Delay Time 开启延迟时间 ( $V_{DS} = -15\text{V}, I_D = -1\text{A}, R_{GEN}=2.5\Omega, V_{GS} = -10\text{V}$ )	$t_{d(on)}$	—	5	—	ns
Turn-ON Rise Time 开启上升时间 ( $V_{DS} = -15\text{V}, I_D = -1\text{A}, R_{GEN}=2.5\Omega, V_{GS} = -10\text{V}$ )	$t_r$	—	26	—	ns
Turn-OFF Delay Time 关断延迟时间 ( $V_{DS} = -15\text{V}, I_D = -1\text{A}, R_{GEN}=2.5\Omega, V_{GS} = -10\text{V}$ )	$t_{d(off)}$	—	50	—	ns
Turn-OFF Fall Time 关断下降时间 ( $V_{DS} = -15\text{V}, I_D = -1\text{A}, R_{GEN}=2.5\Omega, V_{GS} = -10\text{V}$ )	$t_f$	—	43	—	ns

## Typical Characteristic Curve 典型特性曲线

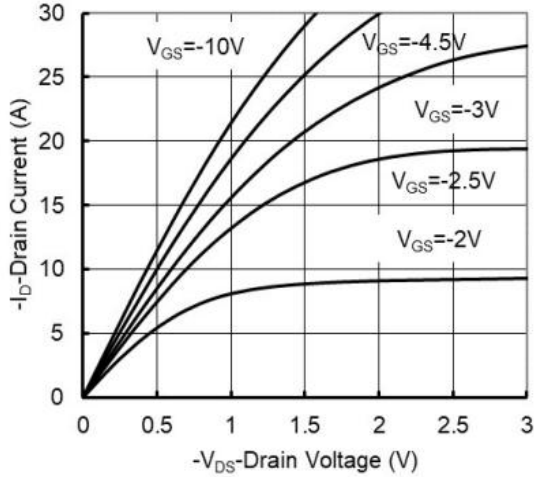


Figure 1: Output Characteristics

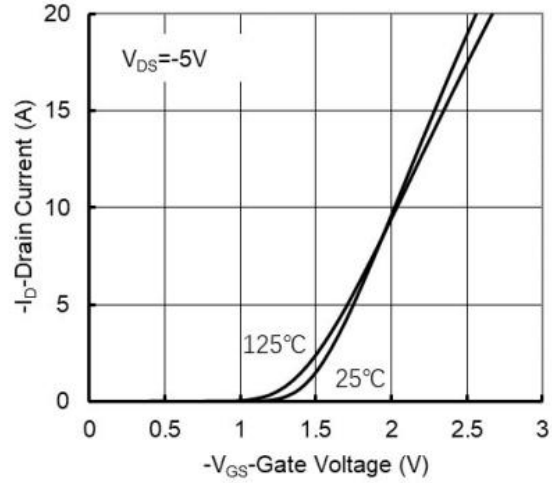


Figure 2: Transfer Characteristics

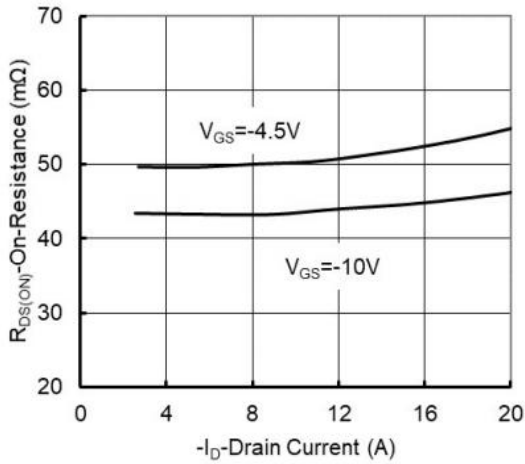


Figure 3: On-Resistance vs. Drain Current

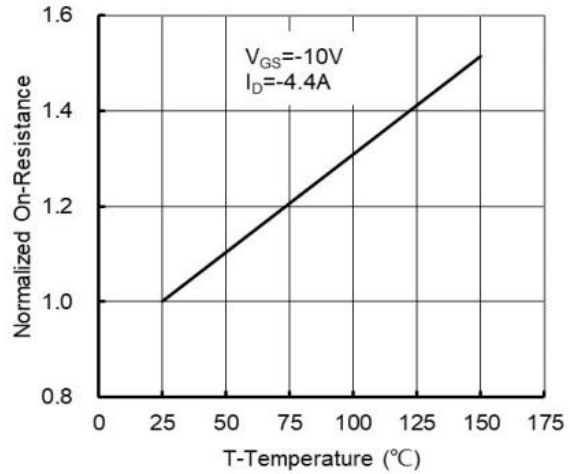


Figure 4: On-Resistance vs. Temperature

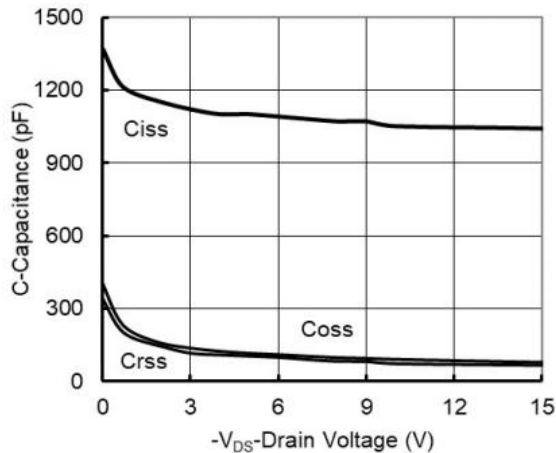


Figure 5: Capacitance Characteristics

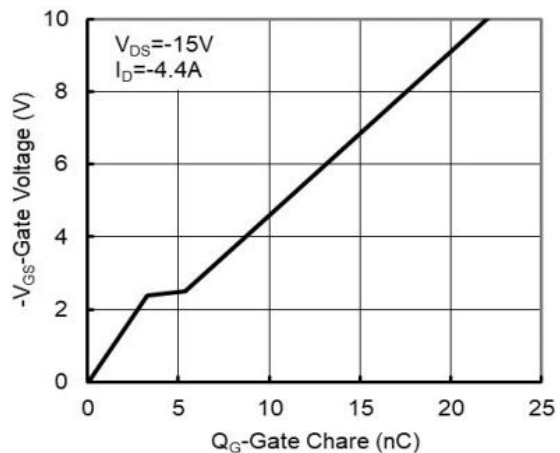


Figure 6: Gate-Charge Characteristics

## ■ Typical Characteristic Curve 典型特性曲线

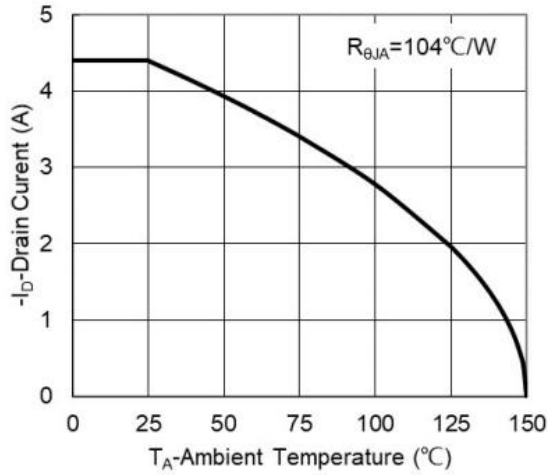


Figure 7: Drain Current vs. Temperature

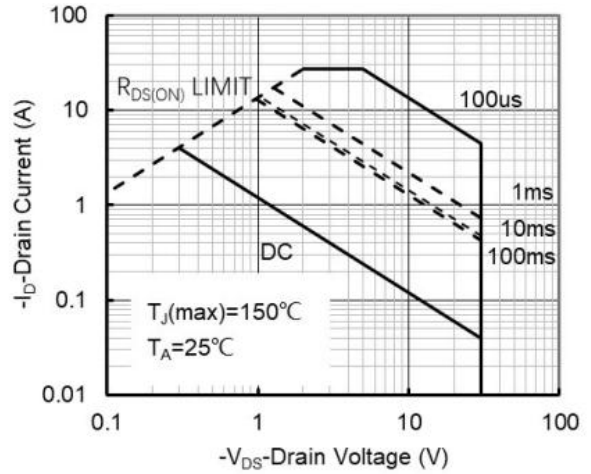


Figure 8: Safe Operating Area

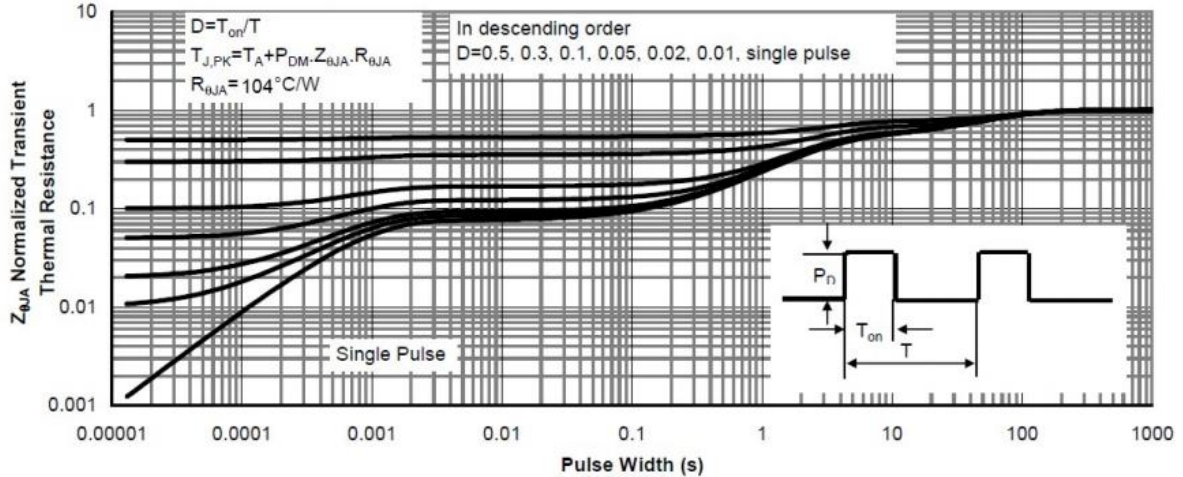
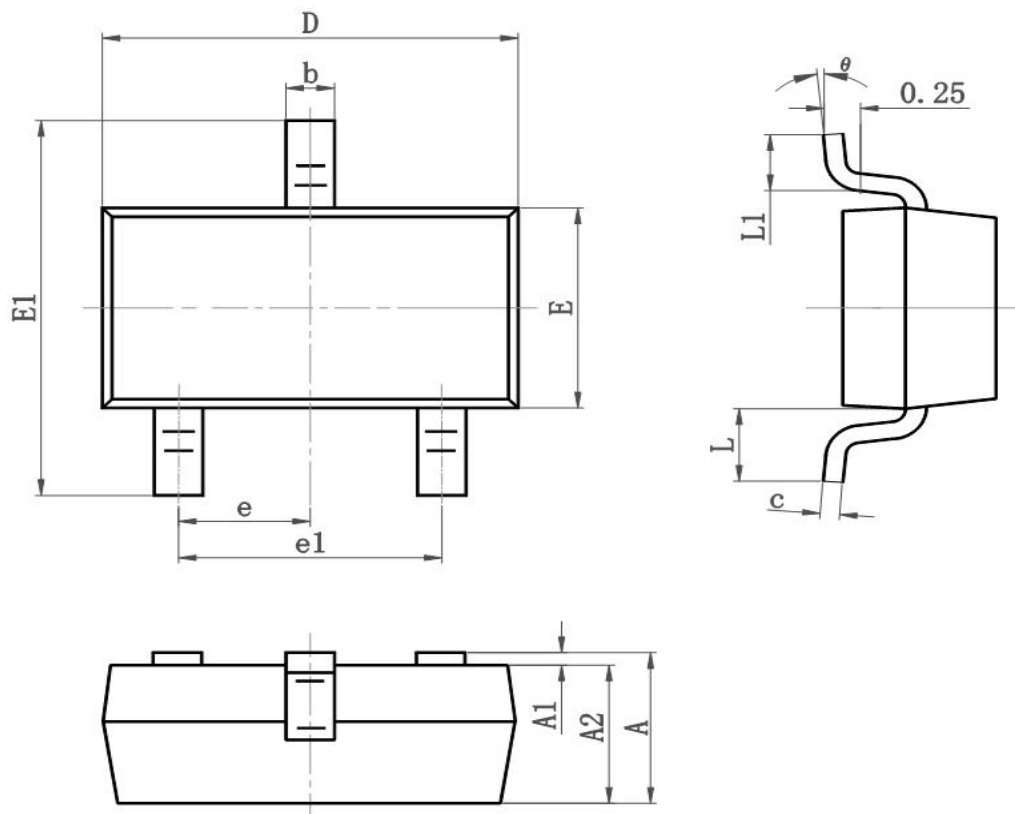


Figure 9: Transient Thermal Response Curve

## Dimension 外形封装尺寸



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.050	0.055
E1	2.250	2.550	0.089	0.100
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
$\theta$	0°	8°	0°	8°

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